

Excellent Integrated System Limited

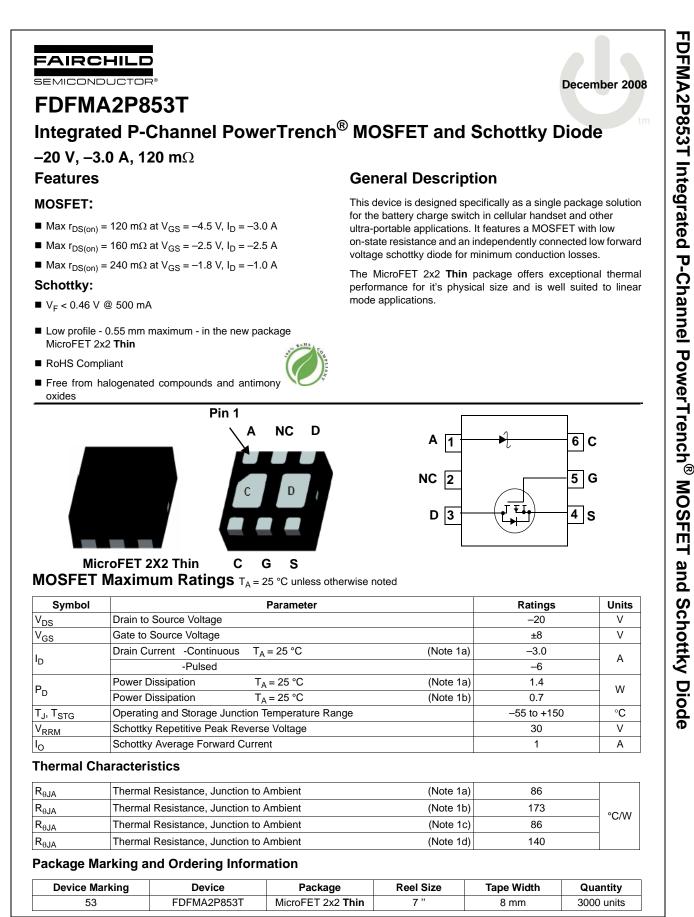
Stocking Distributor

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Fairchild Semiconductor FDFMA2P853T

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>





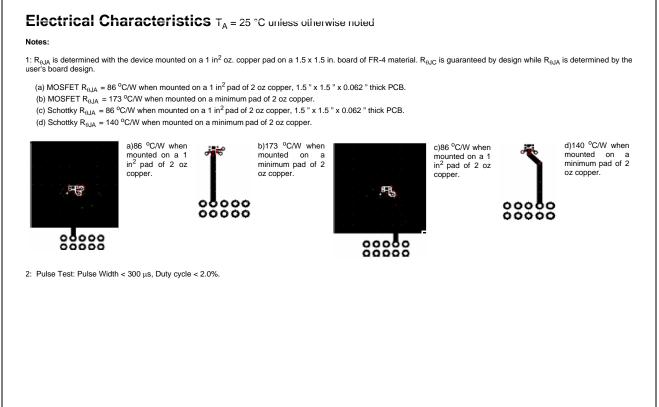


Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	acteristics	1		-1		1	1
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _G	r = 0 V	-20			V
ΔBV_{DSS}	Breakdown Voltage Temperature	$I_D = -250 \ \mu A$, referenced to 25 °C		20	-12		mV/°C
ΔTJ	Coefficient	-					
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$ $V_{GS} = \pm 8 V, V_{DS} = 0 V$				-1	μA
I _{GSS}	Gate to Source Leakage Current	$v_{GS} = \pm o v, v_{DS}$	= 0 V			±100	nA
	icteristics						-
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$		-0.4	-0.7	-1.3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient $I_D = -250 \mu A$, referenced to 25 °C		erenced to 25 °C		2		mV/°C
Ŭ		$V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A}$			90	120	mΩ
		$V_{GS} = -2.5 \text{ V}, \ I_D = -2.5 \text{ A}$			120	160	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -1.8 \text{ V}, I_D = -1.0 \text{ A}$			172	240	
		V _{GS} = −4.5 V, I _D = −3.0 A T _J = 125 °C			118	160	
9 _{FS}	Forward Transconductance	$V_{DS} = -5 V, I_D = -3.0 A$			7		S
	Characteristics					I	
C _{iss}	Input Capacitance			435		pF	
C _{oss}	Output Capacitance	- V _{DS} = –10 V, V _{GS} = 0 V, f = 1.0 MHz			80		pF
C _{rss}	Reverse Transfer Capacitance				45		pF
t _{d(on)}	g Characteristics			9	18	ns	
t _r	Rise Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			11	19	ns
t _{d(off)}	Turn-Off Delay Time Fall Time				15 6	27 12	ns
<u>ч</u> О	Total Gate Charge	V _{DD} = -10 V, I _D = -3.0 A V _{GS} = -4.5 V			4	6	ns nC
Q _{g(TOT)}	Gate to Source Gate Charge				0.8	0	nC
Q _{gs} Q _{gd}	Gate to Drain "Miller" Charge				0.0		nC
	urce Diode Characteristics						
I _S	Maximum Continuous Drain-Source Dioc	le Forward Current	1			-1.1	Α
V _{SD}	Source to Drain Diode Forward Voltage				-0.8	-1.2	V
t _{rr}	Reverse Recovery Time				17		ns
Q _{rr}	Reverse Recovery Charge	I _F = -3.0 A, di/dt = 100 A/μs			6		nC
	Diode Characteristics				<u> </u>	Į	4
		V - 5 V	T _J = 25 °C		9.9	50	μA
I _R	Reverse Leakage	V _R = 5 V	T _J = 125 °C		2.3	10	mA
I _R	Reverse Leakage	V _R = 20 V	T _J = 25 °C		9.9	100	μΑ
			T _J = 85 °C		0.3	1	mA
			T _J = 125 °C		2.3	10	mA
V _F	Forward Voltage	I _F = 500 mA	T _J = 25 °C		0.4	0.46	V
			T _J = 125 °C		0.3	0.35	V
V _F	Forward Voltage	I _F = 1 A	T _J = 25 °C	-	0.5	0.55	V
		•	T _J = 125 °C	1	0.49	0.54	V

FDFMA2P853T Integrated P-Channel PowerTrench[®] MOSFET and Schottky Diode

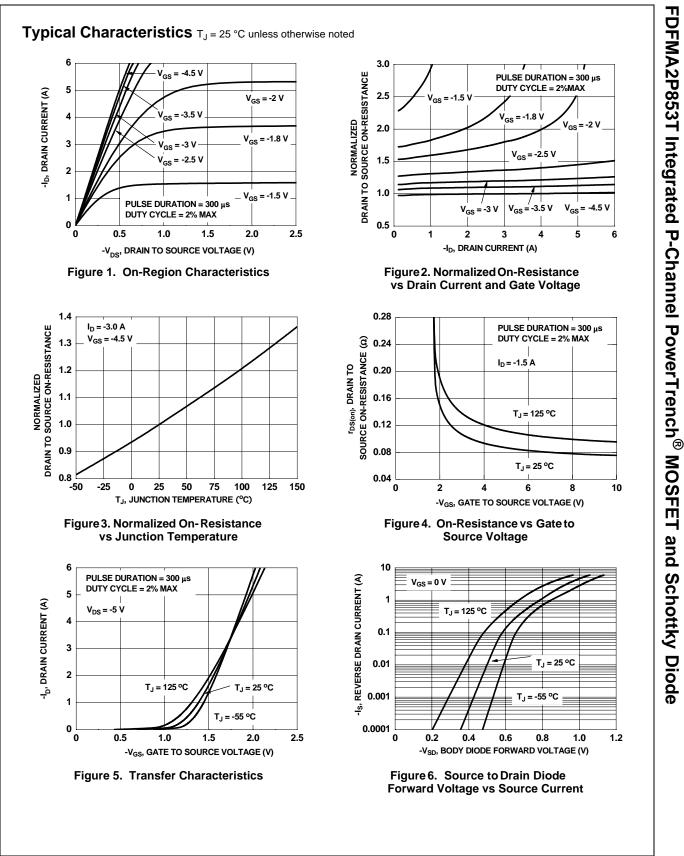
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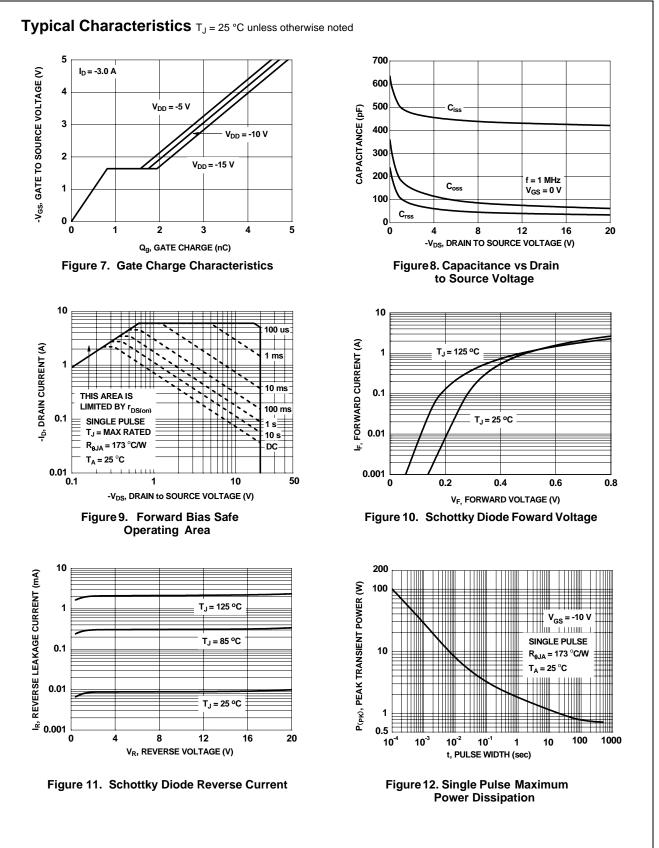


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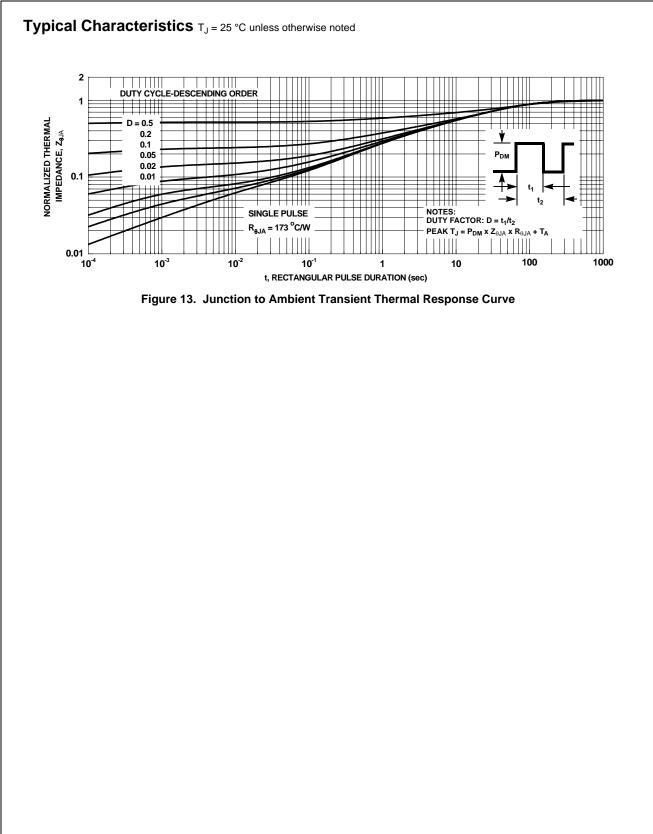






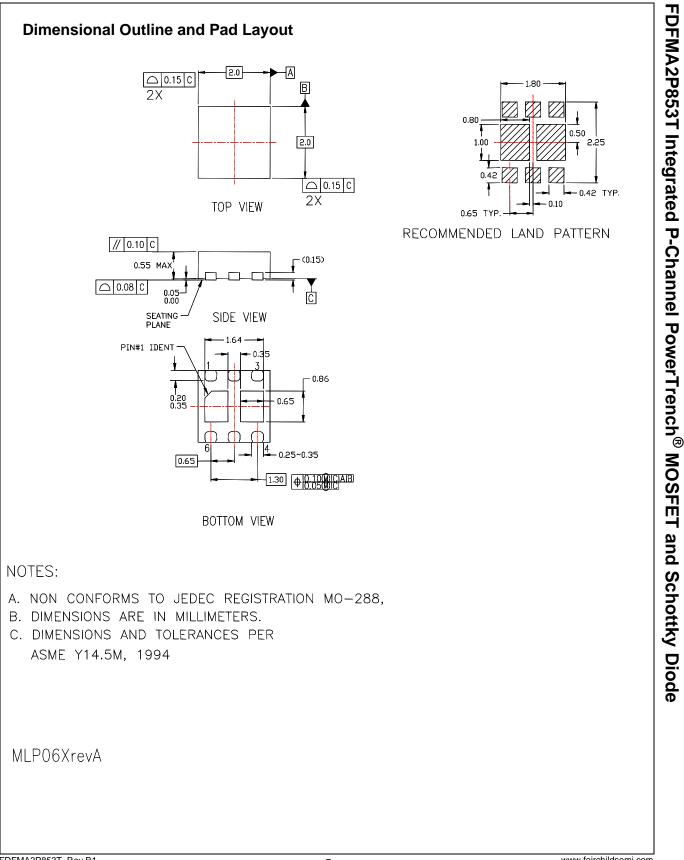
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